

## HIGH VOLTAGE FAST-SWITCHING NPN POWER TRANSISTOR

- STMicroelectronics PREFERRED SALES TYPE
- HIGH VOLTAGE CAPABILITY
- LOW SPREAD OF DYNAMIC PARAMETERS
- MINIMUM LOT-TO-LOT SPREAD FOR RELIABLE OPERATION
- VERY HIGH SWITCHING SPEED
- LARGE RBSOA
- INTEGRATED ANTIPARALLEL COLLECTOR-EMITTER DIODE

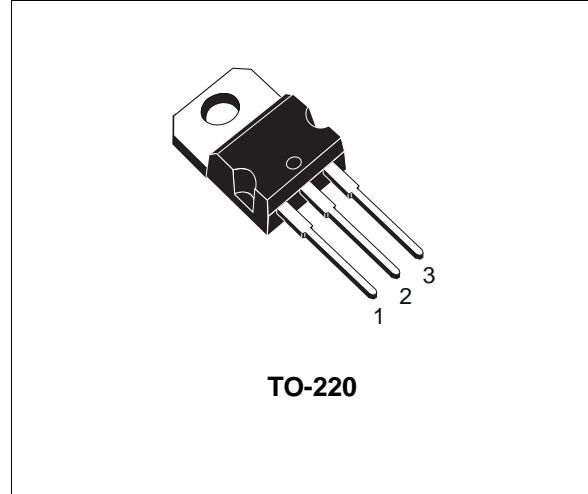
### APPLICATIONS

- ELECTRONIC TRANSFORMERS FOR HALOGEN LAMPS
- ELECTRONIC BALLASTS FOR FLUORESCENT LIGHTING
- SWITCH MODE POWER SUPPLIES

### DESCRIPTION

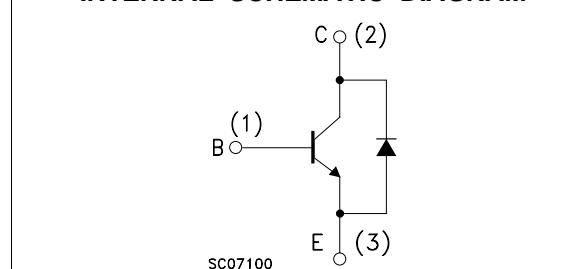
The BUL381D is manufactured using high voltage Multi Epitaxial Planar technology for high switching speeds and high voltage capability.

The BUL series is designed for use in lighting applications and low cost switch-mode power supplies.



**TO-220**

### INTERNAL SCHEMATIC DIAGRAM



### ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
$V_{CES}$	Collector-Emitter Voltage ( $V_{BE} = 0$ )	800	V
$V_{CEO}$	Collector-Emitter Voltage ( $I_B = 0$ )	400	V
$V_{EBO}$	Emitter-Base Voltage ( $I_C = 0$ )	9	V
$I_C$	Collector Current	5	A
$I_{CM}$	Collector Peak Current ( $t_p < 5 \text{ ms}$ )	8	A
$I_B$	Base Current	2	A
$I_{BM}$	Base Peak Current ( $t_p < 5 \text{ ms}$ )	4	A
$P_{tot}$	Total Dissipation at $T_c = 25^\circ\text{C}$	70	W
$T_{stg}$	Storage Temperature	-65 to 150	$^\circ\text{C}$
$T_j$	Max. Operating Junction Temperature	150	$^\circ\text{C}$

# BUL381D

## THERMAL DATA

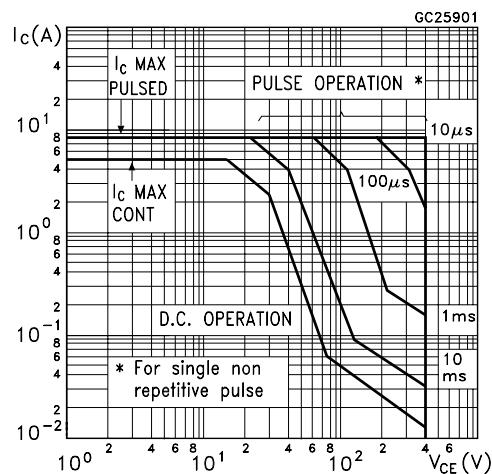
R <sub>thj-case</sub>	Thermal Resistance Junction-Case	Max	1.78	°C/W
R <sub>thj-amb</sub>	Thermal Resistance Junction-Ambient	Max	62.5	°C/W

## ELECTRICAL CHARACTERISTICS ( $T_{case} = 25^\circ\text{C}$ unless otherwise specified)

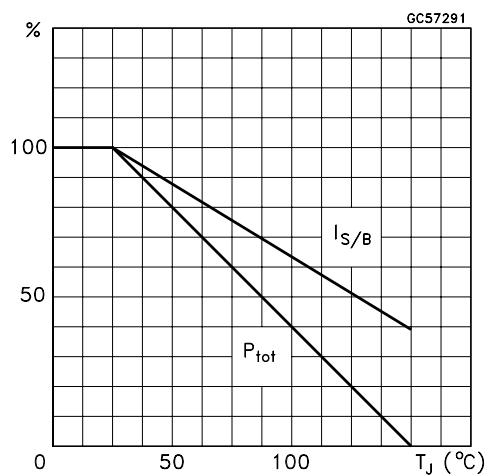
Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
I <sub>CES</sub>	Collector Cut-off Current ( $V_{BE} = 0$ )	$V_{CE} = 800 \text{ V}$ $V_{CE} = 800 \text{ V} \quad T_j = 125^\circ\text{C}$			100 500	μA μA
I <sub>CEO</sub>	Collector Cut-off Current ( $I_B = 0$ )	$V_{CE} = 400 \text{ V}$			250	μA
V <sub>C EO(sus)*</sub>	Collector-Emitter Sustaining Voltage ( $I_B = 0$ )	$I_C = 100 \text{ mA} \quad L = 25 \text{ mH}$	400			V
V <sub>EBO</sub>	Emitter-Base Voltage ( $I_C = 0$ )	$I_E = 10 \text{ mA}$	9			V
V <sub>CE(sat)*</sub>	Collector-Emitter Saturation Voltage	$I_C = 1 \text{ A} \quad I_B = 0.2 \text{ A}$ $I_C = 2 \text{ A} \quad I_B = 0.4 \text{ A}$ $I_C = 3 \text{ A} \quad I_B = 0.75 \text{ A}$			0.5 0.7 1.1	V V V
V <sub>BE(sat)*</sub>	Base-Emitter Saturation Voltage	$I_C = 1 \text{ A} \quad I_B = 0.2 \text{ A}$ $I_C = 2 \text{ A} \quad I_B = 0.4 \text{ A}$			1.1 1.2	V V
h <sub>FE*</sub>	DC Current Gain	$I_C = 2 \text{ A} \quad V_{CE} = 5 \text{ V}$ $I_C = 10 \text{ mA} \quad V_{CE} = 5 \text{ V}$	8 10			
t <sub>s</sub> t <sub>f</sub>	RESISTIVE LOAD Storage Time Fall Time	$I_C = 2 \text{ A} \quad V_{CC} = 250 \text{ V} \quad t_p = 30 \mu\text{s}$ $I_{B1} = -I_{B2} = 0.4 \text{ A}$	1.5		2.5 0.8	μs μs
t <sub>s</sub> t <sub>f</sub>	INDUCTIVE LOAD Storage Time Fall Time	$I_C = 2 \text{ A} \quad I_{B1} = 0.4 \text{ A}$ $V_{BE(off)} = -5 \text{ V} \quad R_{BB} = 0 \Omega$ $V_{CL} = 250 \text{ V} \quad L = 200 \mu\text{H}$ $T_j = 125^\circ\text{C}$		1.3 100		μs ns
V <sub>f</sub>	Diode Forward Voltage	$I_C = 2 \text{ A}$			2.5	V

\* Pulsed: Pulse duration = 300 μs, duty cycle 1.5 %

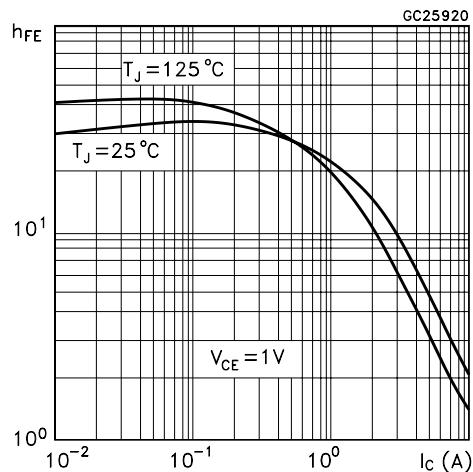
## Safe Operating Area



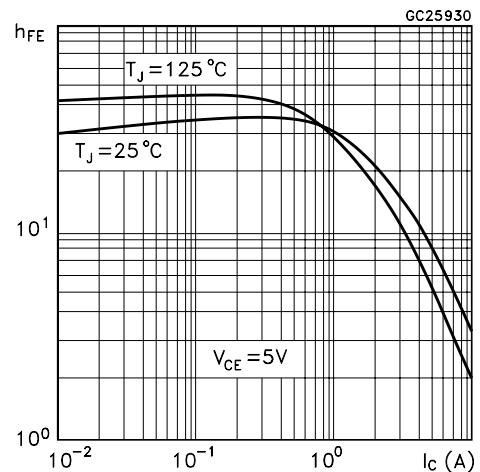
## Derating Curve



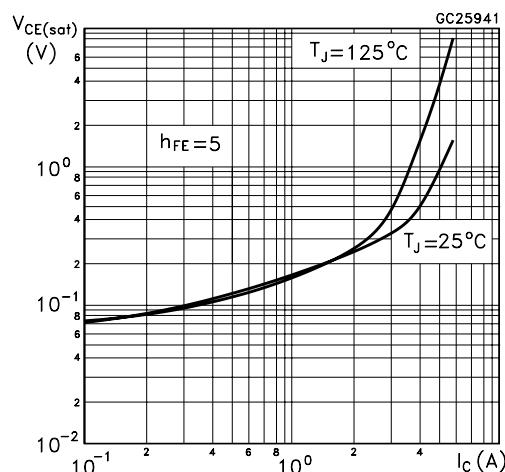
## DC Current Gain



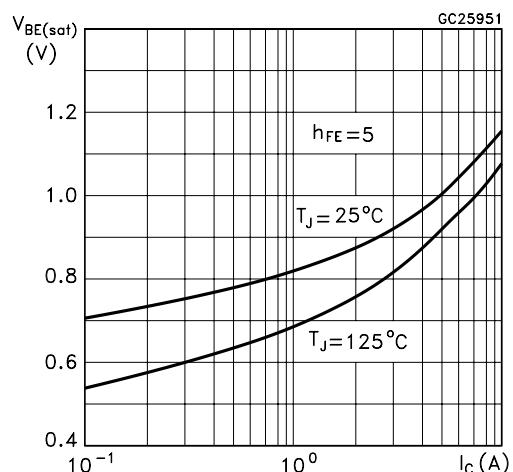
## DC Current Gain



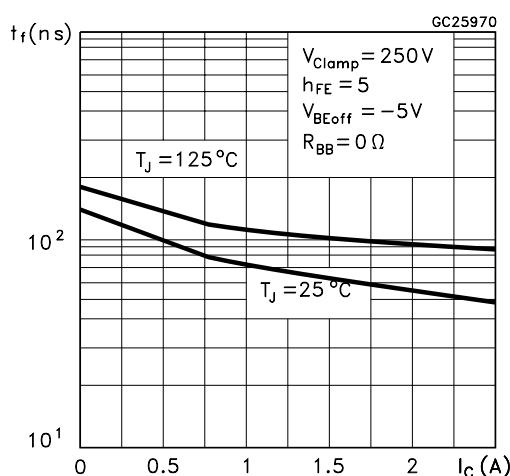
## Collector Emitter Saturation Voltage



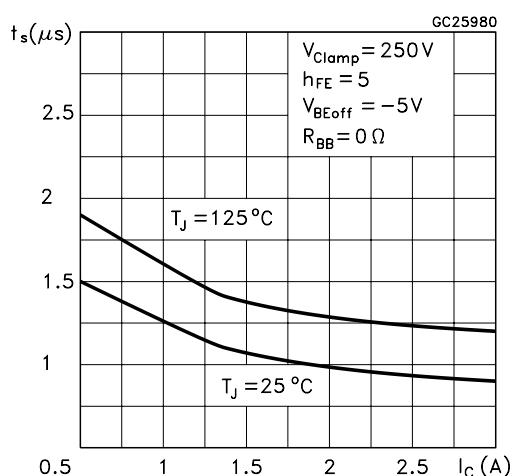
## Base Emitter Saturation Voltage



## Inductive Fall Time

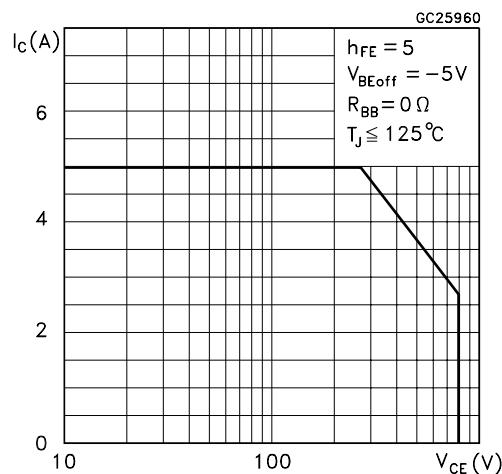


## Inductive Storage Time

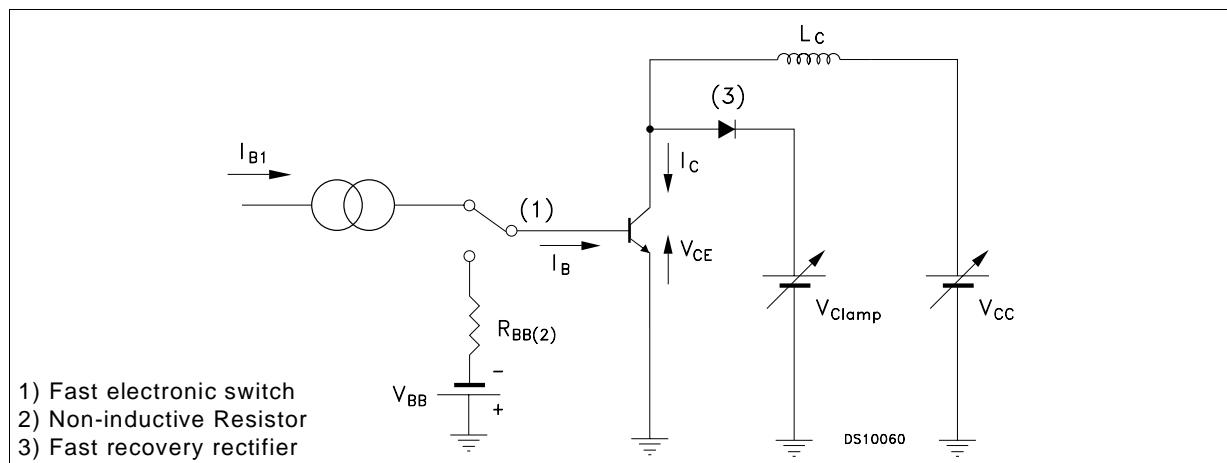


## BUL381D

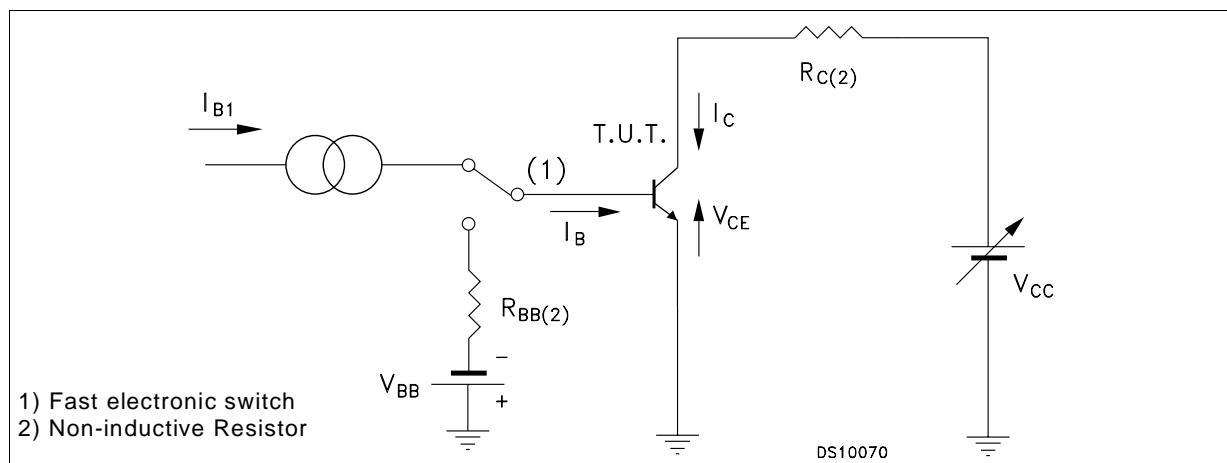
### Reverse Biased SOA



### Inductive Load Switching Test Circuit

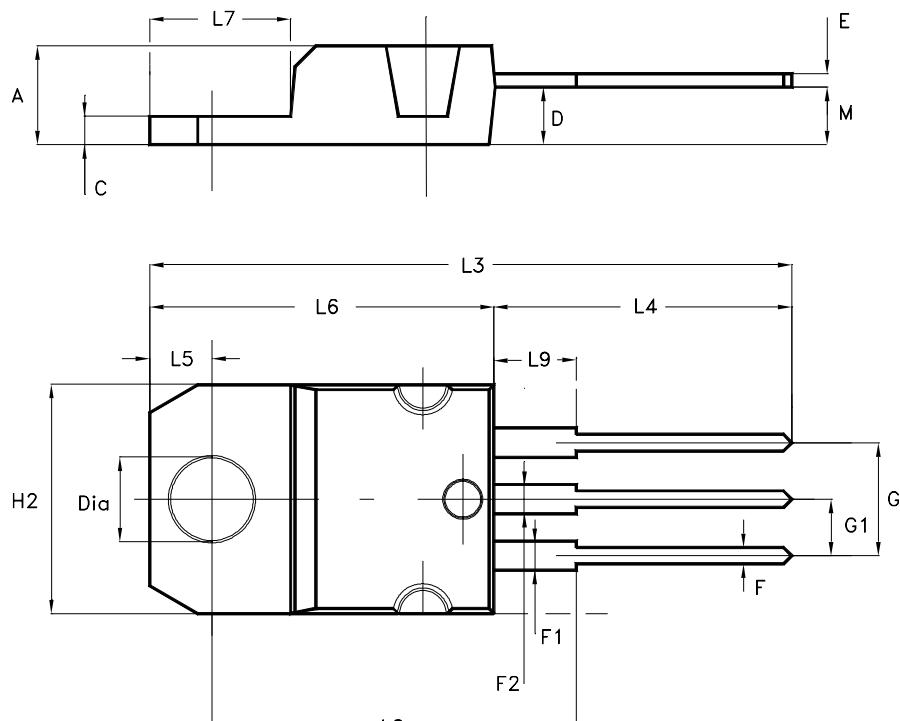


### Resistive Load Switching Test Circuit



## TO-220 MECHANICAL DATA

DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A	4.40		4.60	0.173		0.181
C	1.23		1.32	0.048		0.052
D	2.40		2.72	0.094		0.107
E	0.49		0.70	0.019		0.027
F	0.61		0.88	0.024		0.034
F1	1.14		1.70	0.044		0.067
F2	1.14		1.70	0.044		0.067
G	4.95		5.15	0.194		0.202
G1	2.40		2.70	0.094		0.106
H2	10.00		10.40	0.394		0.409
L2		16.40			0.645	
L4	13.00		14.00	0.511		0.551
L5	2.65		2.95	0.104		0.116
L6	15.25		15.75	0.600		0.620
L7	6.20		6.60	0.244		0.260
L9	3.50		3.93	0.137		0.154
M		2.60			0.102	
DIA.	3.75		3.85	0.147		0.151



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**Офис по работе с юридическими лицами:**

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: [info@moschip.ru](mailto:info@moschip.ru)

Skype отдела продаж:

moschip.ru  
moschip.ru\_4

moschip.ru\_6  
moschip.ru\_9